











LP2951-33-Q1, LP2951-50-Q1

SLVSAW6E -JUNE 2011 - REVISED NOVEMBER 2014

LP2951-xx-Q1 Adjustable Micropower Voltage Regulators With Shutdown

Features

Qualified for Automotive Applications

Wide Input Range: Up to 35 V

Rated Output Current of 100 mA

Low Dropout: 380 mV (Typ) at 100 mA

Low Quiescent Current: 75 µA (Typ)

Tight Line Regulation: 0.03% (Typ)

Tight Load Regulation: 0.04% (Typ)

High V_O Accuracy

- 1.4% at 25°C

2% Over Temperature

Can Be Used as a Regulator or Reference

Stable With Low ESR (>12 mΩ) Capacitors

Current- and Thermal-Limiting Features

8-Pin Package

Fixed Voltages: 5 V/ADJ and 3.3 V/ADJ

Low-Voltage Error Signal on Falling Output

Shutdown Capability

Remote Sense Capability for Optimal Output Regulation and Accuracy

2 Applications

- **Automotive Power**
 - Battery to MCU Regulator
 - Sensor Supply
 - Infotainment
 - Body Control Module
- Secondary Side Regulation
- Point of Load Regulation

3 Description

The LP2951-xx-Q1 devices are bipolar, low-dropout voltage regulators that can accommodate a wide input supply-voltage range of up to 35 V. The 8-pin LP2951-xx-Q1 is able to output either a fixed or adjustable output from the same device. By tying the OUTPUT and SENSE pins together, and the FEEDBACK and V_{TAP} pins together, the LP2951-xx-Q1 outputs a fixed 5 V and 3.3 V (depending on the version). Alternatively, by leaving the SENSE and V_{TAP} pins open and connecting FEEDBACK to an external resistor divider, the output can be set to any value between 1.235 V to 30 V.

The 8-pin LP2951-xx-Q1 also offers additional functionality that makes it particularly suitable for battery-powered applications. For example, a logiccompatible shutdown feature allows the regulator to be put in standby mode for power savings. In addition, there is a built-in supervisor reset function in which the ERROR output goes low when V_{OUT} drops by 6% of its nominal value for whatever reasons due to a drop in V_{IN}, current limiting, or thermal shutdown.

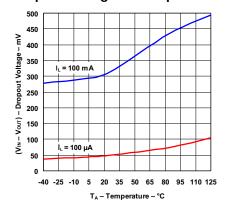
The LP295x-xx-Q1 devices are designed to minimize all error contributions to the output voltage. With a tight output tolerance (0.5% at 25°C), a very low output voltage temperature coefficient (20 ppm typical), extremely good line and load regulation (0.3% and 0.4% typical), and remote sensing capability, the parts can be used as either low-power voltage references or 100-mA regulators.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
LP2951-33-Q1	COIC (9)	4.00 mm 2.00 mm		
LP2591-50-Q1	SOIC (8)	4.90 mm × 3.90 mm		
LP2951-50-Q1	WSON (8)	3.00 mm × 3.00 mm		

⁽¹⁾ For all available packages, see the orderable addendum at the end of the data sheet.

Dropout Voltage vs Temperature





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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

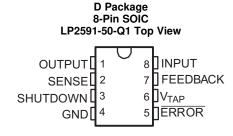
CI	langes from Revision D (April 2013) to Revision E	Page
•	Added Handling Rating table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section	1
CI	nanges from Revision C (February 2013) to Revision D	Page
•	Deleted unreleased devices	1
<u>.</u>	Added the THERMAL INFORMATION table	4
Cł	nanges from Revision B (December 2012) to Revision C	Page
•	Deleted P/N LP2951-Q1 from page header	1
<u>.</u>	Deleted ORDERING INFORMATION table	3
Cl	nanges from Revision A (July 2012) to Revision B	Page
<u>.</u>	Changed LP2951-33QDRGRQ1 From: Preview To: Active	3
CI	nanges from Original (June, 2011) to Revision A	Page
•	Removed continuous from input voltage range parameter description; changed max values for V_{IN} and V_{SHDN} from 30 to 35	3

Product Folder Links: LP2951-33-Q1 LP2951-50-Q1

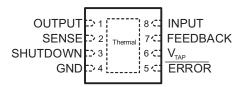
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Pin Configuration and Functions



DRG Package 8-Pin WSON With Exposed Thermal Pad **Top View**



Pin Functions

DIN					
PIN		TYPE	DESCRIPTION		
NAME	NO.		DESCRIPTION		
ERROR	5	0	Active-low open-collector error output. Goes low when $\rm V_{OUT}$ drops by 6% of its nominal value.		
FEEDBACK	7	1	Determines the output voltage. Connect to V_{TAP} (with OUTPUT tied to SENSE) to output the fixed voltage corresponding to the part version, or connect to a resistor divider to adjust the output voltage.		
GND	4	_	Ground		
INPUT	8	I	Supply input		
OUTPUT	1	0	Voltage output.		
SENSE	2	I	Senses the output voltage. Connect to OUTPUT (with FEEDBACK tied to V_{TAP}) to output the voltage corresponding to the part version.		
SHUTDOWN	3	ı	Active-high input. Shuts down the device.		
V _{TAP}	6	0	Tie to FEEDBACK to output the fixed voltage corresponding to the part version.		

Specifications

6.1 Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{IN}	Input voltage range	-0.3	35	V
V_{SHDN}	SHUTDOWN input voltage range	-1.5	35	V
	ERROR comparator output voltage range (2)	-1.5	30	V
V_{FDBK}	FEEDBACK input voltage range (2) (3)	-1.5	30	V
T_J	Operating virtual-junction temperature		150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 Handling Ratings

				MIN	MAX	UNIT
T _{stg}	Storage temperature range			-65	150	°C
V _(ESD)	Electrostatic discharge	Human body model (HBM), per AEC Q100-002 ⁽¹⁾⁽²⁾		0	2000	
		Charged device model (CDM), per AEC Q100-011 Corner pins (1, 4, 8 and 5) Other pins	Corner pins (1, 4, 8, and 5)	0	1000	V
			Other pins	0	1000	

AEC Q100-002 indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

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May exceed input supply voltage

If load is returned to a negative power supply, the output must be diode clamped to GND.

LP2951-50QDRQ1 Feedback pin survives up to 1500V HBM



6.3 Recommended Operating Conditions

		MIN	NOM MAX	UNIT
V _{IN}	Supply input voltage	See (1)	30	V
T _A	Operating temperature	-40	129	°C

Minimum V_{IN} is the greater of:

 (a) 2 V (25°C), 2.3 V (over temperature), or
 (b) V_{OUT(MAX)} + Dropout (Max) at rated I_L

6.4 Thermal Information

		LP2951-30-Q1, LP2951-50-Q1	LP2951-50-Q1	
	THERMAL METRIC	DRG	D	UNIT
		8 PINS	8 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	55.7	121.6	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	66.5	69.8	
$R_{\theta JB}$	Junction-to-board thermal resistance	30.2	61.9	°C/W
ΨЈТ	Junction-to-top characterization parameter	1.1	22.2	-C/VV
ΨЈВ	Junction-to-board characterization parameter	30.4	61.4	
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	10	n/a	

6.5 Electrical Characteristics

 $V_{IN} = V_{OUT}$ (nominal) + 1 V, $I_L = 100 \,\mu\text{A}$, $C_L = 1 \,\mu\text{F}$ (5-V versions) or $C_L = 2.2 \,\mu\text{F}$ (3.3-V versions), 8-pin version: FEEDBACK tied to V_{TAP} , OUTPUT tied to SENSE, $V_{SHUTDOWN} \leq 0.7 \,\text{V}$

	PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
3.3-V VERS	SION (LP2951-33-Q1)		,				
V	Outrat valta aa	1 1004	25°C	3.267	3.3	3.333	V
V _{OUT}	Output voltage	I _L = 100 μA	-40°C to 125°C	3.234	3.3	3.366	V
5-V VERSIC	ON (LP2951-50-Q1)			·			
· · · · · · · · · · · · · · · · · · ·	Output valtage	1 1004	25°C	4.950	5	5.050	V
V _{OUT}	Output voltage	I _L = 100 μA	-40°C to 125°C	4.900	5	5.100	V
ALL VOLTA	AGE OPTIONS						
	Output voltage temperature coefficient ⁽¹⁾	Ι _L = 100 μΑ	-40°C to 125°C		20	100	ppm/°C
	1: (2)	V 5V 4 VI +- 00 V	25°C	·	0.03	0.2	0/ 0/
	Line regulation ⁽²⁾	$V_{IN} = [V_{OUT(NOM)} + 1 V] \text{ to } 30 V$	-40°C to 125°C	·		0.4	%/V
	1 (2)	1 100 100 1	25°C	·	0.04%	0.2%	
	Load regulation (2)	$I_L = 100 \ \mu A \text{ to } 100 \ \text{mA}$	-40°C to 125°C	·		0.3%	
	(3)	I _L = 100 μA	25°C		50	80	mV
., .,			-40°C to 125°C	· · · · · · · · · · · · · · · · · · ·		150	
$V_{IN} - V_{OUT}$	Dropout voltage (3)		25°C	· · · · · · · · · · · · · · · · · · ·	380	450	
		I _L = 100 mA	-40°C to 125°C	·		600	
		1 1004	25°C	·	75	120	
	OND	I _L = 100 μA	-40°C to 125°C	·		140	μA
I _{GND}	GND current	100 1	25°C	·	8	12	4
		I _L = 100 mA	-40°C to 125°C			14	mA
	Dropout around ourrest	$V_{IN} = V_{OUT(NOM)} - 0.5 V,$	25°C	•	110	170	
	Dropout ground current	$I_L = 100 \mu A$	-40°C to 125°C	•		200	μA
	Current limit	V 0.V	25°C	•	160	200	A
	Current limit	V _{OUT} = 0 V	-40°C to 125°C	,		220	mA

(1) Output or reference voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.

(2) Regulation is measured at constant junction temperature, using pulse testing with a low duty cycle. Changes in output voltage due to heating effects are covered under the specification for thermal regulation.

(3) Dropout voltage is defined as the input-to-output differential at which the output voltage drops 100 mV, below the value measured at 1-V differential. The minimum input supply voltage of 2 V (2.3 V over temperature) must be observed.

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Electrical Characteristics (continued)

 $V_{IN} = V_{OUT}$ (nominal) + 1 V, $I_L = 100 \mu A$, $C_L = 1 \mu F$ (5-V versions) or $C_L = 2.2 \mu F$ (3.3-V versions), 8-pin version: FEEDBACK tied to V_{TAP} , OUTPUT tied to SENSE, $V_{SHUTDOWN} \le 0.7 \text{ V}$

PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
Thermal regulation (4)	I _L = 100 μA	25°C		0.05	0.2	%/W
	C _L = 1 μF (5 V only)		·	430		
Output noise (RMS),	C _L = 200 μF	25°C	·	160		μV
10 Hz to 100 kHz	LP2951-50-Q1: $C_L = 3.3 \ \mu F$, $C_{Bypass} = 0.01 \ \mu F$ between pins 1 and 7			100		μ.
Reference voltage (5)	$ \begin{aligned} &V_{OUT} = V_{REF} \text{ to } (V_{IN}-1 \text{ V}), \\ &V_{IN} = 2.3 \text{ V to } 30 \text{ V}, \\ &I_L = 100 \mu\text{A to } 100 \text{ mA} \end{aligned} $	-40°C to 125°C	1.200		1.272	٧
Reference voltage temperature coefficient ⁽¹⁾		25°C		20		ppm/°C
ERROR COMPARATOR						
0.1.1.1.	V 90 V	25°C		0.01	1	
Output leakage current	V _{OUT} = 30 V	-40°C to 125°C	·		2	μA
Outrot law as be as	$V_{IN} = V_{OUT(NOM)} - 0.5 \text{ V},$ $I_{OL} = 400 \mu A$	25°C	·	150	250	\/
Output low voltage		-40°C to 125°C	·		400	mV
Upper threshold voltage		25°C	40	60		mV
(ERROR output high) ⁽⁶⁾		-40°C to 125°C	25			IIIV
Lower threshold voltage		25°C	25°C 75		95	mV
(ERROR output low) (6)		-40°C to 125°C			140	IIIV
Hysteresis (6)		25°C		15		mV
SHUTDOWN INPUT	•		·			
lanut lagia valtaga	Low (regulator ON)	-40°C to 125°C			0.7	V
Input logic voltage	High (regulator OFF)	-40°C to 125°C	2			V
	$V_{TAP} = 2.4 \text{ V}$	25°C		30	50	
CHUTDOWN input gurrent	V _{TAP} = 2.4 V	-40°C to 125°C			100	
SHUTDOWN input current	V 00 V	25°C		450	600	μA
	$V_{TAP} = 30 \text{ V}$	-40°C to 125°C	·		750	
Regulator output current	V _{SHUTDOWN} ≥ 2 V,	25°C		3	10	
in shutdown	$V_{IN} \le 30 \text{ V}, V_{OUT} = 0,$ FEEDBACK tied to V_{TAP}	-40°C to 125°C			20	μA

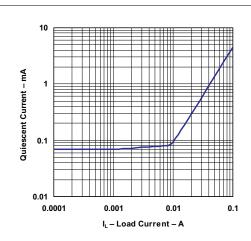
⁽⁴⁾ Thermal regulation is defined as the change in output voltage at a time (T) after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 50-mA load pulse at $V_{IN}=30$ V, $V_{OUT}=5$ V (1.25-W pulse) for t = 10 ms. For LP2951-50QDR in SOIC package, VREF is tested at $V_{IN}=6$ V and $I_{OUT}=100$ μA

Product Folder Links: LP2951-33-Q1 LP2951-50-Q1

Comparator thresholds are expressed in terms of a voltage differential equal to the nominal reference voltage (measured at $V_{IN} - V_{OUT} = 1 \text{ V}$) minus FEEDBACK terminal voltage. To express these thresholds in terms of output voltage change, multiply by the error amplifier gain = V_{OUT}/V_{REF} = (R1 + R2)/R2. For example, at a programmed output voltage of 5 V, the ERROR output is specified to go low when the output drops by 95 mV × 5 V/1.235 V = 384 mV. Thresholds remain constant as a percentage of V_{OUT} (as V_{OUT} is varied), with the low-output warning occurring at 6% below nominal (typical) and 7.7% (maximum).

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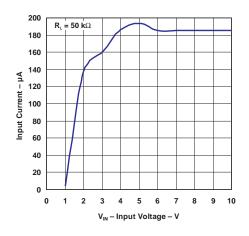
6.6 Typical Characteristics



100 90 80 70 Input Current – µA 60 50 40 30 20 10 0 1 2 3 5 6 7 0 V_{IN} - Input Voltage - V

Figure 1. Quiescent Current vs Load Current

Figure 2. Input Current vs Input Voltage



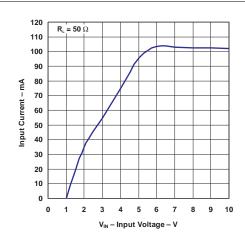
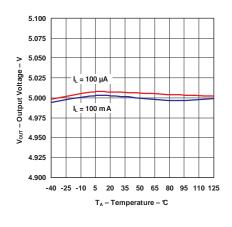


Figure 3. Input Current vs Input Voltage

Figure 4. Input Current vs Input Voltage



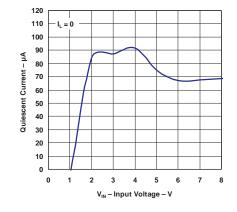


Figure 5. Output Voltage vs Temperature

Figure 6. Quiescent Current vs Input Voltage



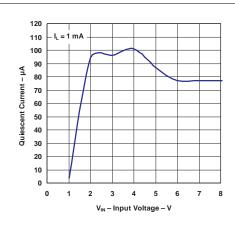


Figure 7. Quiescent Current vs Input Voltage

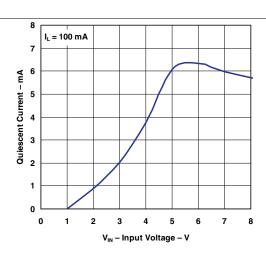


Figure 8. Quiescent Current vs Input Voltage

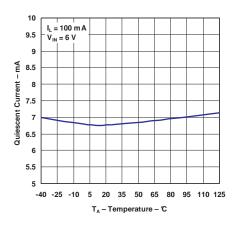


Figure 9. Quiescent Current vs Temperature

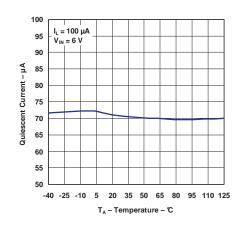


Figure 10. Quiescent Current vs Temperature

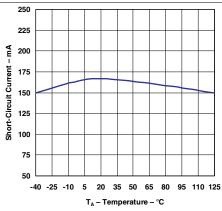


Figure 11. Short-Circuit Current vs Temperature

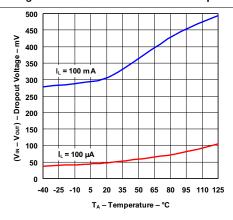


Figure 12. Dropout Voltage vs Temperature

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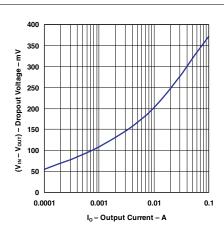


Figure 13. Dropout Voltage vs Output Current

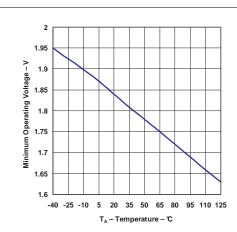


Figure 14. Minimum Operating Voltage vs Temperature

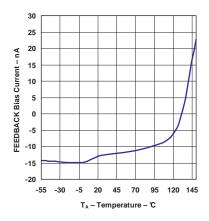


Figure 15. Feedback Bias Current vs Temperature

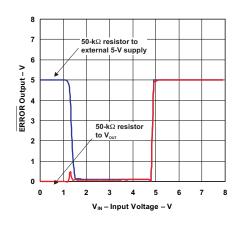


Figure 16. ERROR Comparator Output vs Input Voltage

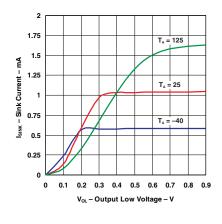


Figure 17. ERROR Comparator Sink Current vs Output Low Voltage

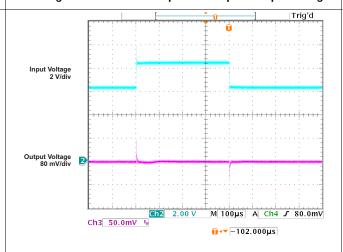


Figure 18. Line Transient Response vs Time



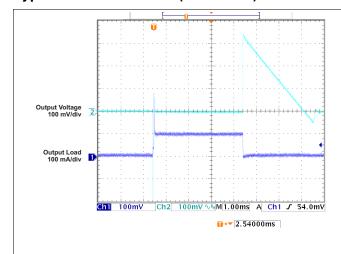


Figure 19. Load Transient Response vs Time $(V_{OUT} = 5 \text{ V}, C_L = 1 \mu\text{F})$

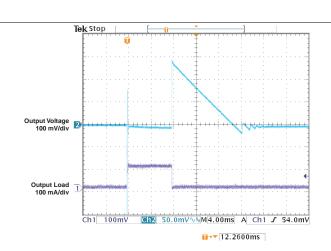


Figure 20. Load Transient Response vs Time ($V_{OUT} = 5 \text{ V}, C_L = 10 \mu\text{F}$)

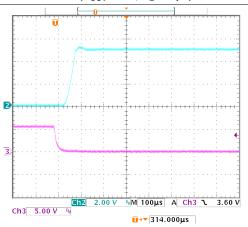


Figure 21. Enable Transient Response vs Time ($C_L = 1 \mu F, I_L = 1 mA$)

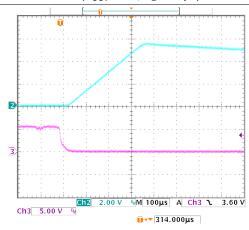


Figure 22. Enable Transient Response vs Time $(C_L=10~\mu F,~I_L=1~mA)$

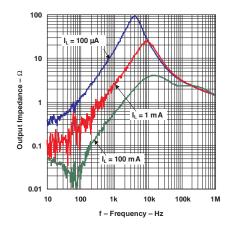


Figure 23. Output Impedance vs Frequency

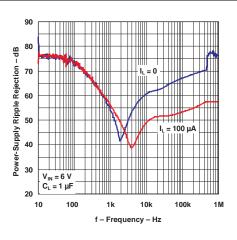
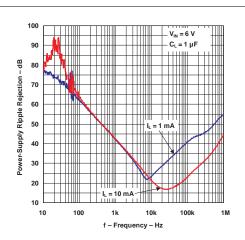


Figure 24. Ripple Rejection vs Frequency

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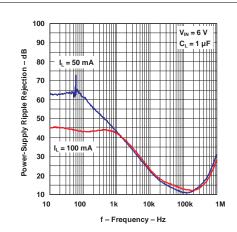
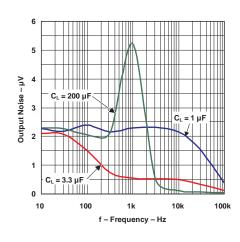


Figure 25. Ripple Rejection vs Frequency





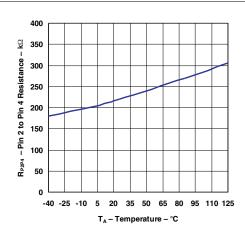
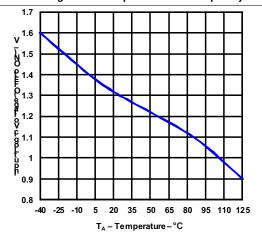


Figure 27. Output Noise vs Frequency

Figure 28. Divider Resistance vs Temperature



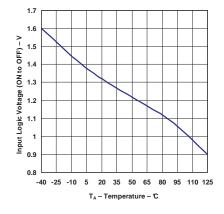
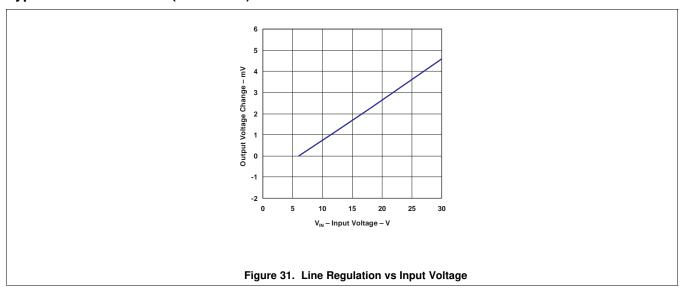


Figure 29. Shutdown Threshold Voltage (OFF to ON) vs
Temperature

Figure 30. Shutdown Threshold Voltage (ON to OFF) vs
Temperature







7 Detailed Description

7.1 Overview

The LP2951-xx-Q1 devices are bipolar, low-dropout voltage regulators that can accommodate a wide input supply-voltage range of up to 30 V. The 8-pin LP2951-xx-Q1 devices are able to output either a fixed or adjustable output from the same device. By tying the OUTPUT and SENSE pins together, and the FEEDBACK and V_{TAP} pins together, the LP2951-xx-Q1 devices output a fixed 5 V, 3.3 V, or 3 V (depending on the version). Alternatively, by leaving the SENSE and V_{TAP} pins open and connecting FEEDBACK to an external resistor divider, the output can be set to any value between 1.235 V to 30 V.

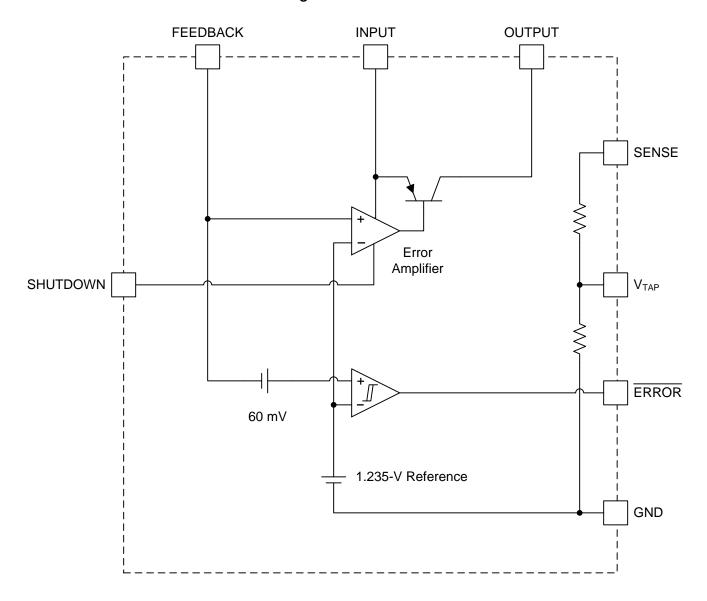
The 8-pin LP2951-xx-Q1 devices also offer additional functionality that makes them particularly suitable for battery-powered applications. For example, a logic-compatible shutdown feature allows the regulator to be put in standby mode for power savings. In addition, there is a built-in supervisor reset function in which the ERROR output goes low when V_{OUT} drops by 6% of its nominal value for whatever reasons – due to a drop in V_{IN} , current limiting, or thermal shutdown.

LP2951-xx-Q1 devices are designed to minimize all error contributions to the output voltage. With a tight output tolerance (0.5% at 25°C), a very low output voltage temperature coefficient (20 ppm typical), extremely good line and load regulation (0.3% and 0.4% typical), and remote sensing capability, the parts can be used as either low-power voltage references or 100-mA regulators.

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7.2 LP2951-xx-Q1 Functional Block Diagram





7.3 Feature Description

7.3.1 ERROR Function

The LP2951-xx-Q1 devices have a low-voltage detection comparator that outputs a logic low when the output voltage drops by \approx 6% from its nominal value, and outputs a logic high when V_{OUT} has reached \approx 95% of its nominal value. This 95% of nominal figure is obtained by dividing the built-in offset of \approx 60 mV by the 1.235-V bandgap reference, and remains independent of the programmed output voltage. For example, the trip-point threshold (ERROR output goes high) typically is 4.75 V for a 5-V output and 11.4 V for a 12-V output. Typically, there is a hysteresis of 15 mV between the thresholds for high and low ERROR output.

A timing diagram is shown in Figure 32 for $\overline{\text{ERROR}}$ vs V_{OUT} (5 V), as V_{IN} is $\underline{\text{ramped}}$ up and down. $\overline{\text{ERROR}}$ becomes valid (low) when $V_{\text{IN}} \approx 1.3$ V. When $V_{\text{IN}} \approx 5$ V, $V_{\text{OUT}} = 4.75$ V, causing $\overline{\text{ERROR}}$ to go high. Because the dropout voltage is load dependent, the output trip-point threshold is reached at different values of V_{IN} , depending on the load current. For instance, at higher load current, $\overline{\text{ERROR}}$ goes high at a slightly higher value of V_{IN} , and vice versa for lower load current. The output-voltage trip point remains at ~4.75 V, regardless of the load. Note that when $V_{\text{IN}} \leq 1.3$ V, the $\overline{\text{ERROR}}$ comparator output is turned off and pulled high to its pullup voltage. If V_{OUT} is used as the pullup voltage, rather than an external 5-V source, $\overline{\text{ERROR}}$ typically is ~1.2 V. In this condition, an equal resistor divider (10 k Ω is suitable) can be tied to $\overline{\text{ERROR}}$ to divide down the voltage to a valid logic low during any fault condition, while still enabling a logic high during normal operation.

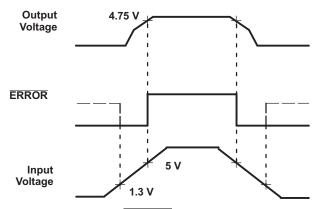


Figure 32. ERROR Output Timing

Because the $\overline{\text{ERROR}}$ comparator has an open-collector output, an external pullup resistor is required to pull the output up to V_{OUT} or another supply voltage (up to 30 V). The output of the comparator is rated to sink up to 400 μA . A suitable range of values for the pullup resistor is from 100 k Ω to 1 M Ω . If $\overline{\text{ERROR}}$ is not used, it can be left open.

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Feature Description (continued)

7.3.2 Programming Output Voltage

A unique feature of the LP2951-xx-Q1 devices are their ability to output either a fixed voltage or an adjustable voltage, depending on the external pin connections. To output the internally programmed fixed voltage, tie the SENSE pin to the OUTPUT pin and the FEEDBACK pin to the V_{TAP} pin. Alternatively, a user-programmable voltage ranging from the internal 1.235-V reference to a 30-V max can be set by using an external resistor divider pair. The resistor divider is tied to V_{OUT} , and the divided-down voltage is tied directly to FEEDBACK for comparison against the internal 1.235-V reference. To satisfy the steady-state condition in which its two inputs are equal, the error amplifier drives the output to equal Equation 1:

$$V_{\text{OUT}} = V_{\text{REF}} \times \left(1 + \frac{R1}{R2}\right) - I_{\text{FB}}R_{1} \tag{1}$$

Where:

V_{REF} = 1.235 V applied across R2 (see Figure 33)

I_{FB} = FEEDBACK bias current, typically 20 nA

A minimum regulator output current of 1 μ A must be maintained. Thus, in an application where a no-load condition is expected (for example, CMOS circuits in standby), this 1- μ A minimum current must be provided by the resistor pair, effectively imposing a maximum value of R2 = 1.2 M Ω (1.235 V/1.2 M Ω * 1 μ A).

 I_{FB} = 20 nA introduces an error of \$0.02% in V_{OUT} . This can be offset by trimming R1. Alternatively, increasing the divider current makes I_{FB} less significant, thus, reducing its error contribution. For instance, using R2 = 100 k Ω reduces the error contribution of I_{FB} to 0.17% by increasing the divider current to \$12 μ A. This increase in the divider current still is small compared to the 600- μ A typical quiescent current of the LP2951-xx-Q1 devices under no load.

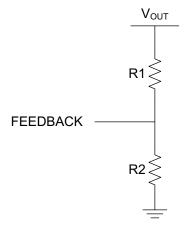


Figure 33. Adjusting the Feedback on the LP2951-xx-Q1

7.4 Device Functional Modes

7.4.1 Shutdown Mode

These devices can be placed in shutdown mode with a logic high at the SHUTDOWN pin. Return the logic level low to restore operation or tie SHUTDOWN to ground if the feature is not being used.

Product Folder Links: *LP2951-33-Q1 LP2951-50-Q1*



8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LP2951-xx-Q1 devices are used as low-dropout regulators with a wide range of input voltages.

8.2 Typical Application

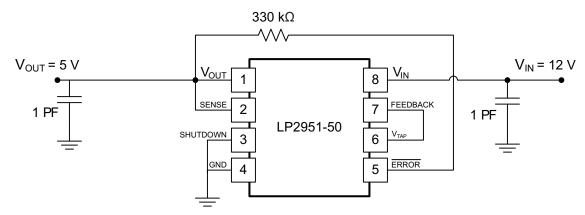


Figure 34. 12-V to 5-V Converter

8.2.1 Design Requirements

8.2.1.1 Input Capacitor (C_{IN})

A 1-µF (tantalum, ceramic, or aluminum) electrolytic capacitor should be placed locally at the input of the LP2951-xx-Q1 device if there is, or will be, significant impedance between the ac filter capacitor and the input; for example, if a battery is used as the input or if the ac filter capacitor is located more than 10 in away. There are no ESR requirements for this capacitor, and the capacitance can be increased without limit.

8.2.1.2 Output Capacitor (C_{OUT})

As with most PNP LDOs, stability conditions require the output capacitor to have a minimum capacitance and an ESR that falls within a certain range.

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Typical Application (continued)

8.2.2 Detailed Design Procedure

8.2.2.1 Capacitance Value

For $V_{OUT} \ge 5$ V, a minimum of 1 μF is required. For lower V_{OUT} , the regulator's loop gain is running closer to unity gain and, thus, has lower phase margins. Consequently, a larger capacitance is needed for stability. For $V_{OUT} = 3$ V or 3.3 V, a minimum of 2.2 μF is recommended. For worst case, $V_{OUT} = 1.23$ V (using the ADJ version), a minimum of 3.3 μF is recommended. C_{OUT} can be increased without limit and only improves the regulator stability and transient response. Regardless of its value, the output capacitor should have a resonant frequency greater than 500 kHz.

The minimum capacitance values given above are for maximum load current of 100 mA. If the maximum expected load current is less than 100 mA, then lower values of C_{OUT} can be used. For instance, if $I_{OUT} < 10$ mA, then only 0.33 μ F is required for C_{OUT} . For $I_{OUT} < 1$ mA, 0.1 μ F is sufficient for stability requirements. Thus, for a worst-case condition of 100-mA load and $V_{OUT} = V_{REF} = 1.235$ V (representing the highest load current and lowest loop gain), a minimum C_{OUT} of 3.3 μ F is recommended.

For the LP2951-xx-Q1 devices, no load stability is inherent in the design — a desirable feature in CMOS circuits that are put in standby (such as RAM keep-alive applications). If the LP2951-xx-Q1 is used with external resistors to set the output voltage, a minimum load current of 1 µA is recommended through the resistor divider.

8.2.2.2 Capacitor Types

Most tantalum or aluminum electrolytics are suitable for use at the input. Film-type capacitors also work but at higher cost. When operating at low temperature, care should be taken with aluminum electrolytics, as their electrolytes often freeze at -30°C. For this reason, solid tantalum capacitors should be used at temperatures below -25°C.

Ceramic capacitors can be used, but due to their low ESR (as low as 5 m Ω to 10 m Ω), they may not meet the minimum ESR requirement previously discussed. If a ceramic capacitor is used, a series resistor between 0.1 Ω to 2 Ω must be added to meet the minimum ESR requirement. In addition, ceramic capacitors have one glaring disadvantage that must be taken into account — a poor temperature coefficient, where the capacitance can vary significantly with temperature. For instance, a large-value ceramic capacitor (\geq 2.2 μ F) can lose more than half of its capacitance as temperature rises from 25°C to 85°C. Thus, a 2.2- μ F capacitor at 25°C drops well below the minimum C_{OUT} required for stability as ambient temperature rises. For this reason, select an output capacitor that maintains the minimum 2.2 μ F required for stability for the entire operating temperature range.

8.2.2.3 C_{BYPASS}: Noise and Stability Improvement

In the LP2951-xx-Q1 devices, an external FEEDBACK pin directly connected to the error amplifier noninverting input can allow stray capacitance to cause instability by shunting the error amplifier feedback to GND, especially at high frequencies. This is worsened if high-value external resistors are used to set the output voltage, because a high resistance allows the stray capacitance to play a more significant role; i.e., a larger RC time delay is introduced between the output of the error amplifier and its FEEDBACK input, leading to more phase shift and lower phase margin. A solution is to add a 100-pF bypass capacitor (C_{BYPASS}) between OUTPUT and FEEDBACK; because C_{BYPASS} is in parallel with R1, it lowers the impedance seen at FEEDBACK at high frequencies, in effect offsetting the effect of the parasitic capacitance by providing more feedback at higher frequencies. More feedback forces the error amplifier to work at a lower loop gain, so C_{OUT} should be increased to a minimum of 3.3 μ F to improve the regulator's phase margin.

 C_{BYPASS} can be also used to reduce output noise in the LP2951-xx-Q1 devices. This bypass capacitor reduces the closed loop gain of the error amplifier at the high frequency, so noise no longer scales with the output voltage. This improvement is more noticeable with higher output voltages, where loop gain reduction is greatest. A suitable C_{BYPASS} is calculated as shown in Equation 2:

$$f_{(CBYPASS)} \simeq 200 \text{ Hz} \rightarrow C_{(BYPASS)} = \frac{1}{2\pi \times R1 \times 200 \text{ Hz}}$$
 (2)



Typical Application (continued)

8.2.2.4 ESR Range

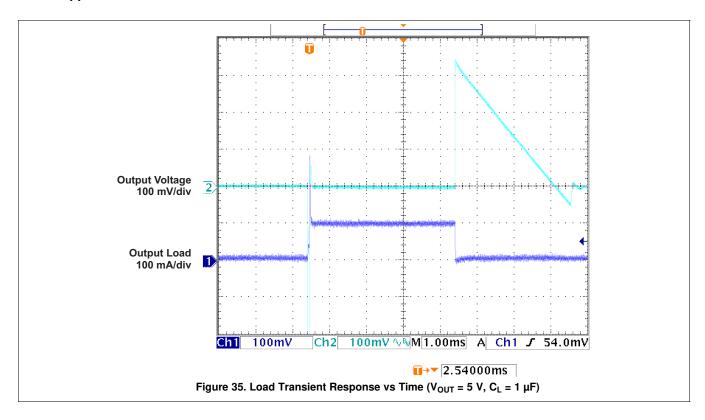
The regulator control loop relies on the ESR of the output capacitor to provide a zero to add sufficient phase margin to ensure unconditional regulator stability; this requires the closed-loop gain to intersect the open-loop response in a region where the open-loop gain rolls off at 20 dB/decade. This ensures that the phase is always less than 180° (phase margin greater than 0°) at unity gain. Thus, a minimum-maximum range for the ESR must be observed.

The upper limit of this ESR range is established by the fact that an ESR that is too high could result in the zero occurring too soon, causing the gain to roll off too slowly. This, in turn, allows a third pole to appear before unity gain and introduces enough phase shift to cause instability. This typically limits the maximum ESR to approximately 5Ω .

Conversely, the lower limit of the ESR range is tied to the fact that an ESR that is too low shifts the zero too far out, past unity gain, which allows the gain to roll off at 40 dB/decade at unity gain, resulting in a phase shift of greater than 180°. Typically, this limits the minimum ESR to approximately 20 m Ω to 30 m Ω .

For specific ESR requirements, see *Typical Characteristics*.

8.2.3 Application Curve



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9 Power Supply Recommendations

Maximum input voltage should be limited to 30 V for proper operation. Place input and output capacitors as close to the device as possible to take advantage of their high frequency noise filtering properties.

10 Layout

10.1 Layout Guidelines

Make sure that traces on the input and outputs of the device are wide enough to handle the desired currents. For this device, the output trace will need to be larger in order to accommodate the larger available current.

Place input and output capacitors as close to the device as possible to take advantage of their high frequency noise filtering properties.

10.2 Layout Example

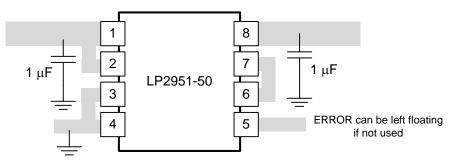


Figure 36. LP2951-xx-Q1 Layout Example (D Package)

11 Device and Documentation Support

11.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 1. Related Links

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY	
LP2951-33-Q1	Click here	Click here	Click here	Click here	Click here	
LP2951-50-Q1	Click here	Click here	Click here	Click here	Click here	

11.2 Trademarks

All trademarks are the property of their respective owners.

11.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.



12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGE OPTION ADDENDUM

6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	_	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LP2951-33QDRGRQ1	ACTIVE	SON	DRG	8	3000	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	RACQ	Samples
LP2951-50QDRGRQ1	ACTIVE	SON	DRG	8	3000	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	ZUFQ	Samples
LP2951-50QDRQ1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-3-260C-168 HR	-40 to 125	KY515Q	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

6-Feb-2020

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LP2951-Q1:

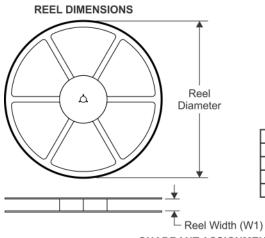
NOTE: Qualified Version Definitions:

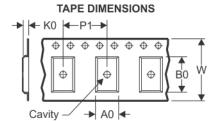
Catalog - TI's standard catalog product

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Apr-2020

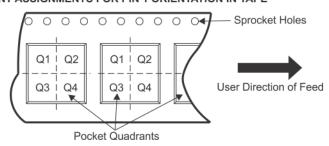
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2951-50QDRGRQ1	SON	DRG	8	3000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
LP2951-50QDRQ1	SOIC	D	8	2500	330.0	12.5	6.4	5.2	2.1	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Apr-2020



*All dimensions are nominal

Device	Device Package Type		Pins SPQ		Length (mm)	Width (mm)	Height (mm)	
LP2951-50QDRGRQ1	SON	DRG	8	3000	367.0	367.0	35.0	
LP2951-50QDRQ1	SOIC	D	8	2500	340.5	338.1	20.6	

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



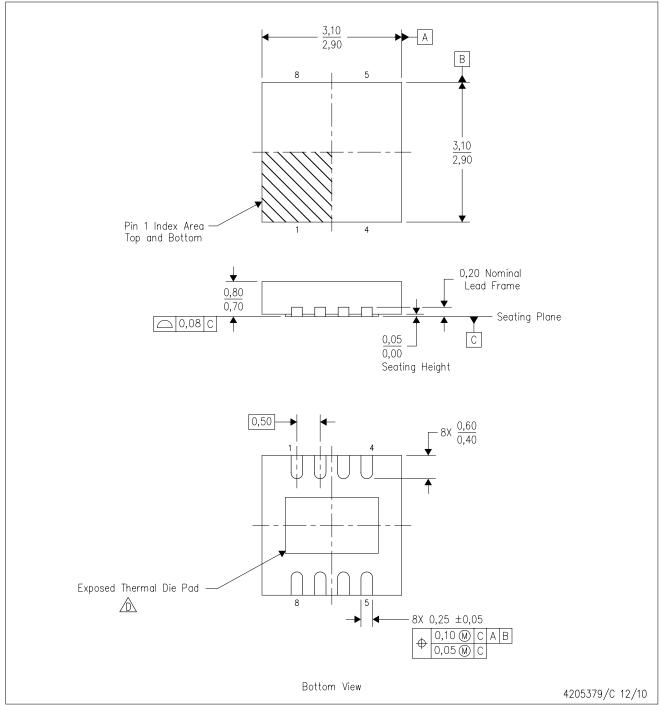
NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



DRG (S-PWSON-N8)

PLASTIC SMALL OUTLINE NO-LEAD

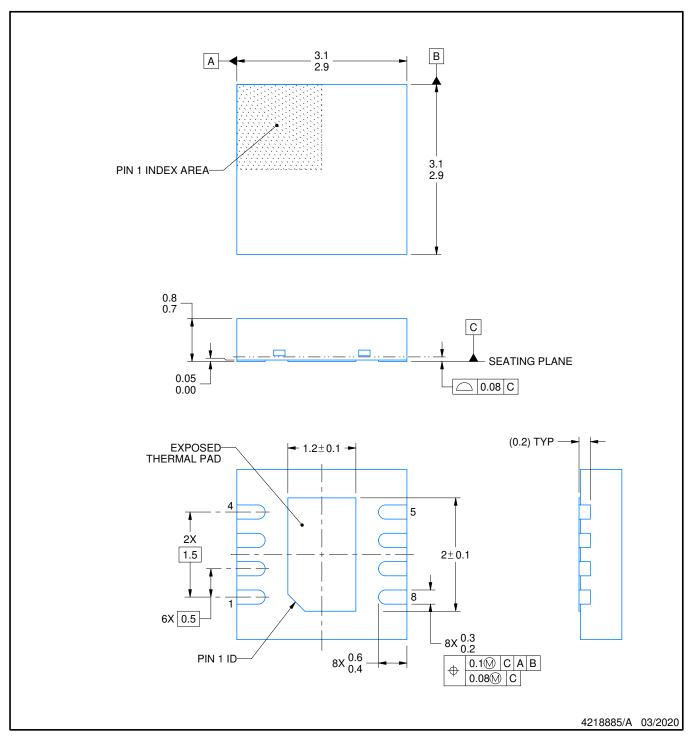


- NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
 - B. This drawing is subject to change without notice.
 - C. SON (Small Outline No-Lead) package configuration.
 - The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
 - E. JEDEC MO-229 package registration pending.



WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

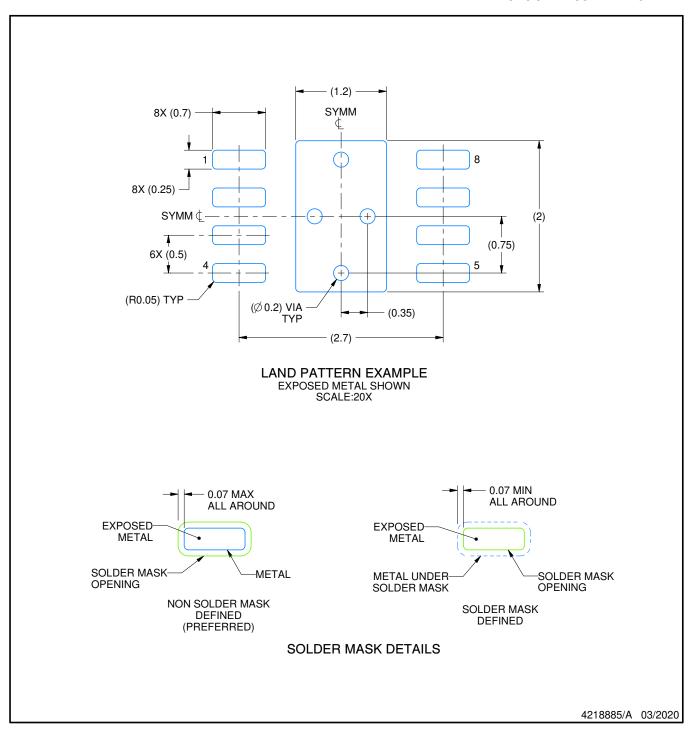


NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC SMALL OUTLINE - NO LEAD

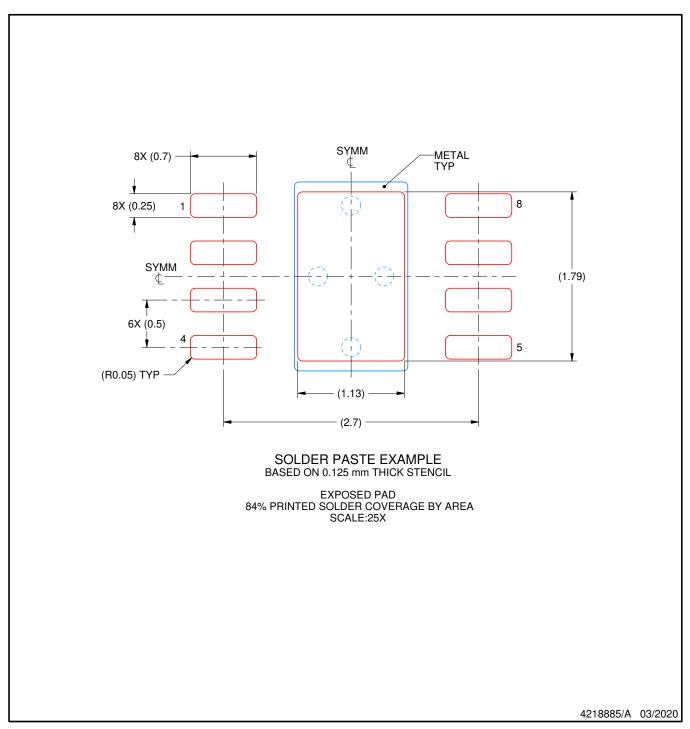


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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